

TAI-SAW TECHNOLOGY CO., LTD.

No. 3, Industrial 2nd Rd., Ping-Chen Industrial District, Taoyuan, 324, Taiwan, R.O.C. TEL: 886-3-4690038 FAX: 886-3-4697532

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Product Specifications Approval Sheet

TST Parts No.: TR0036AA0095

Customer Parts No.:_____

Customer signature required	
Company:	-
Division:	_
Approved by :	-
Date:	

Checked by:	Hong pu Lin	Hong Pu Lin
Approved by:	Andy Yu	Andy In
Date:	2020/09/17	

- 1. Customer signed back is required before TST can proceed with sample build and receive orders.
- 2. Orders received without customer signed back will be regarded as agreement on the specifications.
- 3. Any specifications changes must be approved upon by both parties and a new revision of specifications shall be released to reflect the changes.



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Dielectric Filter 3750MHz size 15.9x4.4mm

MODEL NO.: TR0036AA0095 REV. NO.:1

A. MAXIMUM RATING:

1. Input Power Level: 1W max.

2. DC Voltage: 0 V

3. Operating Temperature: -40 °C to +85 °C

4. Storage Temperature:-40 °C to +85 °C

5. Input/output impedance: 50 Ω

6. Moisture Sensitive Level: Level 2a (MSL2a)

RoHS Compliant Lead free Lead-free soldering

Electrostatic Sensitive Device (ESD)

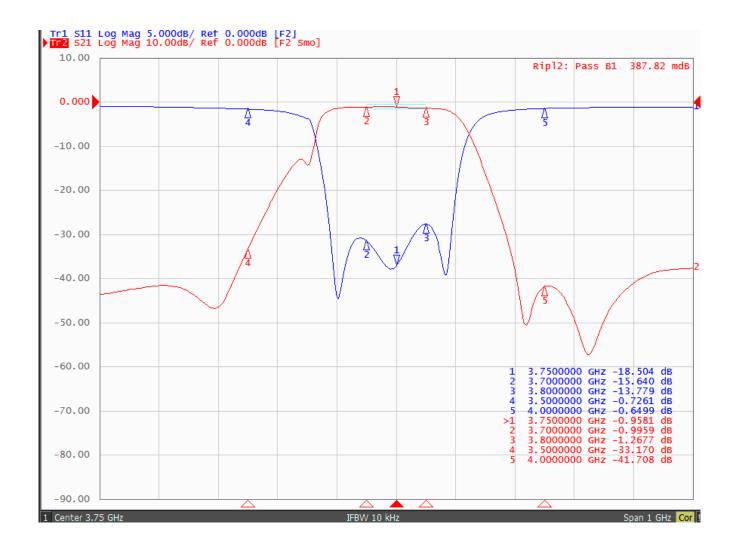
B. ELECTRICAL CHARACTERISTICS:

NO	ITEM		SPECIFICATION	
NO.			Min	Max
1	CENTER FREQUENCY		3750	MHz
2	PASS BAND WIDTH		3700 ~ 3	8800MHz
3	PASS BAND INSERTION LOSS			1.5dB
4	PASS BAND RIPPLE			1.0 dB
5	PASS BAND RETURN LOSS		10 dB	
6	STOP-BAND	3500MHz	30 dB	
	ATTENUATION	4000MHz	20 dB	

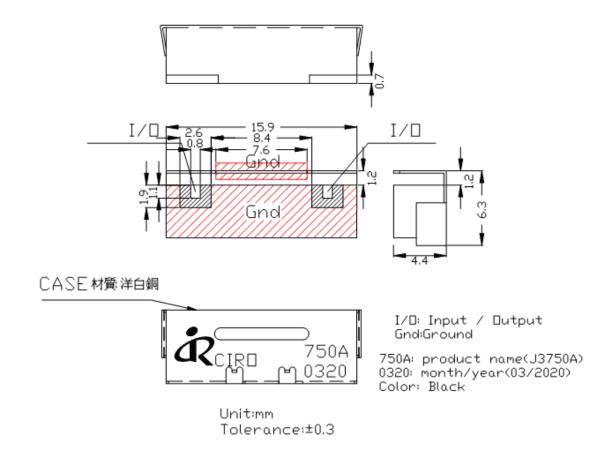
Item NO.4 specifies the absolute value of attenuation

*Data is measured on Cirocomm EVB board

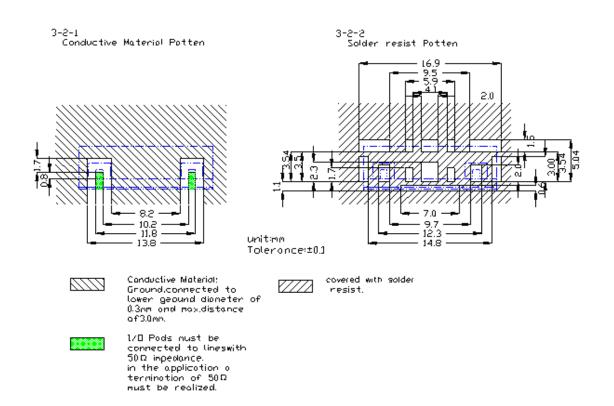
C. FREQUENCY CHARACTERISTICS:



D. **DIMENSION**:



E.PCB FOOTPRINT:

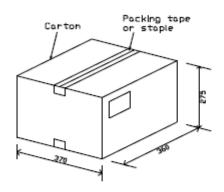


F. PACKING:

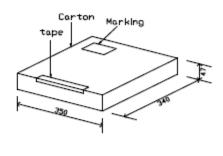
Package style

Moisture Sensitivity Level: Level 2a (MSL2a)

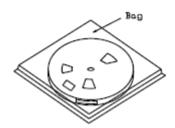
 Duter Carton Quanylty:2500PCS



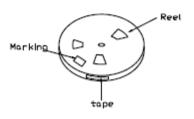
Inner Carton Quanylty:500PCS



Bag Quanylty:500PCS



 Taping Quanylty:500PCS



Unlt:mm

G. RECOMMENDED REFLOW PROFILE:

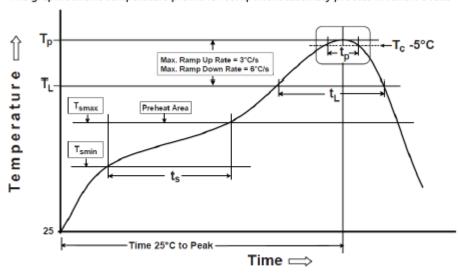
Recommended Reflow Soldering Profile

Cirocomm products can be assembled following Pb-free assembly. According to the Standard IPC/JEDEC J-STD-020C, the temperature profile suggested is as follow:

Phase	Profile features	Pb-Free Assembly (SnAgCu)	
PREHEAT	-Temperature Min(Tsmin) -Temperature Max(Tsmax) -Time(ts) form (Tsmin to Tsmax)	150°C 200°C 60-120 seconds	
RAMP-UP	Avg. Ramp-up Rate (Tsmax to TP)	3°C/second(max)	
REFLOW	-Temperature(TL) -Total Time above TL (t L)	217℃ 30-100 seconds	
PEAK	-Temperature(TP) -Time(tp)	260°C 3 second	
RAMP-DOWN	Rate	6°C / second max.	
Time from 25°C to Peak Temperature		8 minutes max.	
Composition of solder paste		96.5Sn/3Ag/0.5Cu	
Solder Paste Model		SHENMAO PF606-P26	

Note: All the temperature measure point is on top surface of the component, if temperature over recommend, it will make component surface peeling or damage.

The graphic shows temperature profile for component assembly process in reflow ovens



Soldering With Iron:

Soldering condition: Soldering iron temperature 270±10 ℃.

Apply preheating at 120°C for 2-3 minutes. Finish soldering for each terminal within 3 seconds, if soldering iron over temperature 270±10 °C or 3 seconds, it will make component surface peeling or damage. Soldering iron can not leakage of electricity.